

TLS810D1EJV50

Ultra Low Quiescent Current Linear Voltage Regulator

Data Sheet

Rev. 1.0, 2015-01-27

Automotive Power



Ultra Low Quiescent Current Linear Voltage Regulator TLS810D1

TLS810D1EJV50



1 Overview

Features

- Ultra Low Quiescent Current of 9 µA
- Wide Input Voltage Range of 2.75 V to 42 V
- Output Current Capacity up to 100 mA
- Low Drop Out Voltage of typ. 200 mV @ 100 mA
- Enable
- Off-mode Current Less than 1 µA
- Reset
- Output Current Limit Protection
- Overtemperature Shutdown
- Available in PG-DSO-8 EP Package
- Wide Temperature Range
- Green Product (RoHS Compliant)
- AEC Qualified

Description

The TLS810D1 is a linear voltage regulator featuring wide input voltage range, low drop out voltage and ultra low quiescent current.

With an input voltage range of 2.75 V to 42 V and ultra low quiescent of only 9 μ A, the regulator is perfectly suitable for automotive or any other supply systems connected permanently to the battery.

The TLS810D1EJV50 is the fixed 5 V output version with an accuracy of 2 % and output current capability up to 100 mA.

The new regulation concept implemented in TLS810D1 combines fast regulation and very good stability while requiring only a small ceramic capacitor of 1 μ F at the output.

The tracking region starts already at input voltages of 2.75 V (extended operating range). This makes the TLS810D1 also suitable to supply automotive systems that need to operate during cranking condition.

Internal protection features like output current limitation and overtemperature shutdown are implemented to protect the device against immediate damage due to failures like output short circuit to GND, over-current and over-temperature.

The device can be switched on and off by the Enable feature. When the device is switched off, the current consumption is typically less than 1 μ A.

Туре	Package	Marking
TLS810D1EJV50	PG-DSO-8 EP	810D1V50



PG-DSO-8 EP



Overview

The output voltage is supervised by the Reset feature, including undervoltage reset and delayed reset release at power-on.

Choosing External Components

An input capacitor C_1 is recommended to compensate line influences. The output capacitor C_Q is necessary for the stability of the regulating circuit. Stability is guaranteed at values $C_Q \ge 1 \ \mu\text{F}$ and an ESR $\le 100 \ \Omega$ within the whole operating range.



Block Diagram

2 Block Diagram



Figure 1 Block Diagram TLS810D1



Pin Configuration

3 Pin Configuration

3.1 Pin Assignment in PG-DSO-8 EP Package



3.2 Pin Definitions and Functions in PG-DSO-8 EP Package

Pin	Symbol	Function
1	1	Input It is recommended to place a small ceramic capacitor (e.g. 100 nF) to GND, close to the IC terminals, in order to compensate line influences.
2	N.C.	Not connected
3	EN	Enable Integrated pull-down resistor. Enable the IC with high level input signal. Disable the IC with low level input signal.
4	GND	Ground
5	D	Reset Delay Timing Connect a ceramic capacitor to GND for adjusting the reset delay time. Leave open if the reset function is not needed.
6	RO	Reset Output Integrated pull-up resistor. Open collector output. Leave open if the reset function is not needed.
7	N.C.	Not connected





Pin Configuration

Pin	Symbol	Function
8	Q	Output Connect an output capacitor C_Q to GND close to the IC's terminals, respecting the values specified for its capacitance and ESR in Table 2 "Functional Range" on Page 8.
Pad	_	Exposed Pad Connect to heatsink area. Connect to GND.



General Product Characteristics

4 General Product Characteristics

4.1 Absolute Maximum Ratings

Table 1 Absolute Maximum Ratings¹⁾

 T_i = -40 °C to +150 °C; all voltages with respect to ground (unless otherwise specified)

Parameter	Symbol		Value	s	Unit	Note /	Number
		Min.	Тур.	Max.		Test Condition	
Voltage Input, Enable	EN		I	W			I
Voltage	$V_{\rm I}, V_{\rm EN}$	-0.3	-	45	V	-	P_4.1.1
Voltage Output Q				ц.			ù
Voltage	V _Q	-0.3	-	7	V	-	P_4.1.2
Reset Output RO, Res	et Delay D			ц.			ù
Voltage	$V_{\rm RO}, V_{\rm D}$	-0.3	-	7	V	-	P_4.1.3
Temperatures				ц.			ù
Junction Temperature	Tj	-40	-	150	°C	-	P_4.1.4
Storage Temperature	T _{stg}	-55	-	150	°C	-	P_4.1.5
ESD Absorption							t
ESD Absorption	$V_{\rm ESD,HBM}$	-2	-	2	kV	HBM ²⁾	P_4.1.6
ESD Absorption	V _{ESD,CDM}	-750	_	750	V	CDM ³⁾ at all pins	P_4.1.7

1) Not subject to production testing, specified by design.

2) ESD HBM Test according to AEC-Q100-002 - JESD22-A114 (1.5kOhm, 100pF)

3) ESD CDM Test according to ESDA STM5.3.1

Notes

- 1. Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
- 2. Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.



General Product Characteristics

4.2 Functional Range

Table 2Functional Range

Parameter	Symbol		Value	s	Unit	Note / Test Condition	Number
		Min.	Тур.	Max.			
Input Voltage Range	V ₁	$V_{\rm Q,nom}$ + $V_{\rm dr}$	-	42	V	_1)	P_4.2.1
Extended Input Voltage Range	V _{I,ext}	2.75	_	42	V	_2)	P_4.2.2
Output Capacitor	CQ	1	_	-	μF	_ ³⁾	P_4.2.3
Output Capacitor's ESR	$ESR(C_{Q})$	-	-	100	Ω	_ ⁴⁾	P_4.2.4
Junction temperature	Tj	-40	-	150	°C	-	P_4.2.5

1) Output current is limited internally and depends on the input voltage, see Electrical Characteristics for more details.

2) When $V_{\rm I}$ is between $V_{\rm I,ext,min}$ and $V_{\rm Q,nom} + V_{\rm dr}$, $V_{\rm Q} = V_{\rm I} - V_{\rm dr}$. When $V_{\rm I}$ is below $V_{\rm I,ext,min}$, $V_{\rm Q}$ can drop down to 0 V.

3) The minimum output capacitance requirement is applicable for a worst case capacitance tolerance of 30%.

4) Relevant ESR value at f = 10 kHz.

Note: Within the functional or operating range, the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the Electrical Characteristics table.

4.3 Thermal Resistance

Note: This thermal data was generated in accordance with JEDEC JESD51 standards. For more information, go to **www.jedec.org**.

Table 3Thermal Resistance

Parameter	Symbol			Unit	Note / Test Condition	Number	
		Min.	Тур.	Max.			

Package Version PG-DSO-8 EP

U							
Junction to Case ¹⁾	R _{thJC}	_	19	-	K/W	-	P_4.3.1
Junction to Ambient ¹⁾	R_{thJA}	-	51	-	K/W	2s2p board ²⁾	P_4.3.2
Junction to Ambient ¹⁾	R_{thJA}	-	167	-	K/W	1s0p board, footprint only ³⁾	P_4.3.3
Junction to Ambient ¹⁾	R_{thJA}	-	71	-	K/W	1s0p board, 300 mm ² heatsink area on PCB ³⁾	P_4.3.4
Junction to Ambient ¹⁾	R _{thJA}	-	60	-	K/W	1s0p board, 600 mm ² heatsink area on PCB ³⁾	P_4.3.5

1) Not subject to production test, specified by design

 Specified R_{thJA} value is according to Jedec JESD51-2,-5,-7 at natural convection on FR4 2s2p board; The Product (Chip+Package) was simulated on a 76.2 x 114.3 x 1.5 mm³ board with 2 inner copper layers (2 x 70µm Cu, 2 x 35µm Cu). Where applicable a thermal via array under the exposed pad contacted the first inner copper layer.

 Specified R_{thJA} value is according to JEDEC JESD 51-3 at natural convection on FR4 1s0p board; The Product (Chip+Package) was simulated on a 76.2 × 114.3 × 1.5 mm³ board with 1 copper layer (1 x 70μm Cu).



5 Block Description and Electrical Characteristics

5.1 Voltage Regulation

The output voltage $V_{\rm Q}$ is divided by a resistor network. This fractional voltage is compared to an internal voltage reference and the pass transistor is driven accordingly.

The control loop stability depends on the output capacitor C_Q , the load current, the chip temperature and the internal circuit structure. To ensure stable operation, the output capacitor's capacitance and its equivalent series resistor ESR requirements given in "Functional Range" on Page 8 have to be maintained. For details see the typical performance graph **Output Capacitor Series Resistor ESR(C_Q) versus Output Current I_Q**. Since the output capacitor is used to buffer load steps, it should be sized according to the application's needs.

An input capacitor C_1 is not required for stability, but is recommended to compensate line fluctuations. An additional reverse polarity protection diode and a combination of several capacitors for filtering should be used, in case the input is connected directly to the battery line. Connect the capacitors close to the regulator terminals.

In order to prevent overshoots during start-up, a smooth ramping up function is implemented. This ensures almost no overshoots during start-up, mostly independent from load and output capacitance.

Whenever the load current exceeds the specified limit, e.g. in case of a short circuit, the output current is limited and the output voltage decreases.

The overtemperature shutdown circuit prevents the IC from immediate destruction under fault conditions (e.g. output continuously short-circuit) by switching off the power stage. After the chip has cooled down, the regulator restarts. This oscillatory thermal behaviour causes the junction temperature to exceed the maximum rating of 150°C and can significantly reduce the IC's lifetime.



Figure 3 Block Diagram Voltage Regulation



Table 4 Electrical Characteristics

 $T_{\rm j}$ = -40 °C to +150 °C, $V_{\rm l}$ = 13.5 V, all voltages with respect to ground (unless otherwise specified). Typical values are given at $T_{\rm j}$ = 25 °C, $V_{\rm l}$ = 13.5 V.

] =,							
Parameter	Symbol		Value	S	Unit	Note / Test Condition	Number	
		Min. Typ. I		Max.				
Output Voltage Precision	VQ	4.90	5.00	5.10	V	50 μ A $\leq I_Q \leq$ 100 mA, 5.7 V $\leq V_1 \leq$ 28 V	P_5.1.2	
Output Voltage Precision	V _Q	4.90	5.00	5.10	V	50 μ A $\leq I_Q \leq$ 50 mA, 5.7 V $\leq V_1 \leq$ 42 V	P_5.1.3	
Output Current Limitation	$I_{\rm Q,lim}$	110	190	260	mA	$0 \text{ V} \le V_{\text{Q}} \le V_{\text{Q,nom}} - 0.1 \text{ V}$	P_5.1.4	
Line Regulation steady-state	$\varDelta V_{\rm Q,line}$	-	1	20	mV	$I_{\rm Q}$ = 1 mA, 6 V ≤ $V_{\rm I}$ ≤ 32 V	P_5.1.6	
Load Regulation steady-state	$\varDelta V_{\rm Q,load}$	-20	-1	-	mV	$V_1 = 6 \text{ V},$ 50 µA ≤ $I_Q \le 100 \text{ mA}$	P_5.1.7	
Dropout Voltage ¹⁾ $V_{dr} = V_1 - V_Q$	V _{dr}	-	200	550	mV	<i>I</i> _Q = 100 mA	P_5.1.11	
Ripple Rejection ²⁾	PSRR	-	55	-	dB	$I_{\rm Q}$ = 50 mA, $f_{\rm ripple}$ = 100 Hz, $V_{\rm ripple}$ = 0.5 $V_{\rm p-p}$	P_5.1.12	
Overtemperature Shutdown Threshold	$T_{\rm j,sd}$	151	175	-	°C	$T_{\rm j}$ increasing	P_5.1.13	
Overtemperature Shutdown Threshold Hysteresis	$T_{\rm j,sdh}$	-	10	-	К	$T_{\rm j}$ decreasing	P_5.1.14	

1) Measured when the output voltage $V_{\rm Q}$ has dropped 100 mV from the nominal value obtained at $V_{\rm I}$ = 13.5V

2) Not subject to production test, specified by design



5.2 Typical Performance Characteristics Voltage Regulation

Typical Performance Characteristics

Output Voltage V_{Q} versus Junction Temperature T_{i}



Dropout Voltage V_{dr} versus Junction Temperature T_{i}



Output Current $I_{\rm Q}$ versus Input Voltage $V_{\rm I}$



Dropout Voltage $V_{\rm dr}$ versus Output Current $I_{\rm Q}$





Load Regulation $\Delta V_{Q,load}$ versus Output Current I_Q



Output Voltage $V_{\rm Q}$ versus Input Voltage $V_{\rm I}$



Line Regulation $\Delta V_{Q,line}$ versus Input Voltage $V_{\rm I}$



Power Supply Ripple Rejection PSRR versus Ripple Frequency f_r





Output Capacitor Series Resistor $ESR(C_{\rm Q})$ versus Output Current $I_{\rm Q}$





5.3 Current Consumption

Table 5 Electrical Characteristics Current Consumption

 $T_{\rm i}$ = -40 °C to +150 °C, $V_{\rm i}$ = 13.5 V (unless otherwise specified).

Parameter	Symbol	ol Values			Unit	Note / Test Condition	Number	
		Min. Typ.		Max.				
Current Consumption $I_q = I_1$	$I_{q,off}$	-	-	1	μA	$V_{\rm EN} \le 0.4 \text{ V}, T_{\rm j} < 105 \text{ °C}$	P_5.3.1	
Current Consumption $I_q = I_1 - I_Q$	Iq	-	9	11.5	μA	$I_{\rm Q}$ = 50 µA, $T_{\rm j}$ = 25 °C	P_5.3.2	
Current Consumption $I_q = I_1 - I_Q$	Iq	-	11.5	14.5	μA	$I_{\rm Q}$ = 50 µA, $T_{\rm j}$ < 105 °C	P_5.3.3	
$\overline{\text{Current Consumption}}$ $I_{q} = I_{l} - I_{Q}$	Iq	-	12	16	μA	$I_{\rm Q}$ = 50 µA, $T_{\rm j}$ < 125 °C	P_5.3.4	
Current Consumption $I_q = I_l - I_Q$	Iq	-	12	16	μA	$I_{\rm Q}$ = 100 mA, $T_{\rm j}$ < 125 °C	P_5.3.5	



5.4 Typical Performance Characteristics Current Consumption

Typical Performance Characteristics

Current Consumption $I_{\rm q}$ versus Output Current $I_{\rm Q}$



Current Consumption I_q versus Junction Temperature T_j



Current Consumption $I_{\rm q}$ versus Input Voltage $V_{\rm l}$



Current Consumption in OFF mode $I_{q,off}$ versus Junction Temperature T_j





5.5 Enable

The device TLS810D1 can be switched on and off by the Enable feature. Connect a HIGH level as specified below (e.g. the battery voltage) to pin EN to enable the device; connect a LOW level as specified below (e.g. GND) to switch it off. The Enable function has a build-in hysteresis to avoid toggling between ON/OFF state, if signals with slow slopes are appiled to the EN input.

Table 6 Electrical Characteristics Enable

 T_j = -40 °C to +150 °C, V_1 = 13.5 V, all voltages with respect to ground (unless otherwise specified). Typical values are given at T_j = 25 °C, V_1 = 13.5 V.

Parameter	Symbol	Values		Unit	Note / Test Condition	Number	
		Min.	Тур.	Max.			
High Level Input Voltage	$V_{\rm EN,H}$	2	_	-	V	$V_{\rm Q}$ settled	P_5.5.1
Low Level Input Voltage	$V_{\rm EN,L}$	-	_	0.8	V	$V_{\rm Q} \le 0.1 \rm V$	P_5.5.2
High Level Input Current	$I_{\mathrm{EN,H}}$	-	_	4	μA	V _{EN} = 5 V	P_5.5.4
Enable Internal Pull-down Resistor	R _{EN}	1.25	2	3.5	MΩ	-	P_5.5.6



5.6 Typical Performance Characteristics Enable

Typical Performance Characteristics

Enable Input Current $I_{\rm EN}$ versus Enable Input Voltage $V_{\rm EN}$





5.7 Reset Function

The reset function provides several features:

Output Undervoltage Reset

An output undervoltage condition is indicated by setting the Reset Output RO to "low". This signal may be used to reset a microcontroller during low supply voltage.

Power-On Reset Delay Time

The power-on reset delay time t_{rd} allows microcontoller and oscillator to start up. This delay time is the time frame from exceeding the reset switching threshold V_{RT} until the reset is released by switching the reset output "RO" from "low" to "high". The power-on reset delay time trd is defined by an external delay capacitor C_D connected to pin D charged by the delay capacitor charge current $I_{D,ch}$ starting from $V_D = 0$ V.

If the application needs a power-on reset delay time t_{rd} different from the value given in **Table 7**, the delay capacitor's value can be derived from the specified value and the desired power-on delay time:

$$C_{\rm D} = \frac{t_{\rm rd,new}}{t_{\rm rd}} \times 100 \,\mathrm{nF}$$
(5.1)

with

- $C_{\rm D}$: capacitance of the delay capacitor to be chosen
- t_{rd.new}: desired power-on reset delay time
- *t*_{rd}: power-on reset delay time specified in this datasheet

For a precise calculation also take the delay capacitor's tolerance into consideration.

Reset Reaction Time

The reset reaction time avoids that short undervoltage spikes trigger an unwanted reset "low" signal. The reset reaction rime $t_{\rm rr}$ considers the internal reaction time $t_{\rm rr,int}$ and the discharge time $t_{\rm rr,d}$ defined by the external delay capacitor $C_{\rm D}$ (see typical performance graph for details). Hence, the total reset reaction time becomes:

$$t_{\rm rr} = t_{\rm rr,int} + t_{\rm rr,d}$$

with

- *t*_{rr}: reset reaction time
- *t*_{rr.int}: internal reset reaction time
- *t*_{rr.d}: reset discharge

Optional Reset Output Pull-Up Resistor $R_{RO,ext}$

The Reset Output RO is an open collector output with an integrated pull-up resistor. If needed, an external pull-up resistor to the output Q can be added. In **Table 7** a minimum value for the external resistor $R_{\text{RO,ext}}$ is given.

(5.2)

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Block Description and Electrical Characteristics



Figure 4 Block Diagram Reset Function



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Block Description and Electrical Characteristics



Figure 5 Timing Diagram Reset

Table 7 Electrical Characteristics Reset

 $T_{\rm j}$ = -40 °C to +150 °C, $V_{\rm l}$ = 13.5 V, all voltages with respect to ground (unless otherwise specified). Typical values are given at $T_{\rm j}$ = 25 °C, $V_{\rm l}$ = 13.5 V.

Parameter	Symbol		Value	S	Unit	Note / Test Condition	Number
		Min.	Тур.	Max.			
Output Undervoltage Reset	1	1		I			W
Output Undervoltage Reset Upper Switching Threshold	$V_{\rm RT,high}$	4.6	4.7	4.8	V	$V_{\rm Q}$ increasing, $V_{\rm EN} \ge 2.0 \ {\rm V}$	P_5.7.1
Output Undervoltage Reset Lower Switching Threshold	$V_{\rm RT,low}$	4.5	4.6	4.7	V	$V_{\rm Q}$ decreasing, $V_{\rm EN} \ge 2.0 \ {\rm V}$	P_5.7.2
Reset Output RO					·		
Reset Output Low Voltage	$V_{\rm RO,low}$	0	0.2	0.4	V	1 V $\leq V_Q \leq V_{RT}$; $R_{RO} > 4.7 \text{ k}\Omega$	P_5.7.4



Table 7 Electrical Characteristics Reset

 $T_{\rm j}$ = -40 °C to +150 °C, $V_{\rm l}$ = 13.5 V, all voltages with respect to ground (unless otherwise specified). Typical values are given at $T_{\rm j}$ = 25 °C, $V_{\rm l}$ = 13.5 V.

Parameter	Symbol		Values	5	Unit	Note / Test Condition	Number
		Min.	Тур.	Max.			
Reset Output Internal Pull-Up Resistor	R _{RO,int}	13	20	36	kΩ	Internally connected to Q	P_5.7.5
Reset Output External Pull-up Resistor to V_{Q}	R _{RO,ext}	4.7	-	-	kΩ	$1 \vee \leq V_Q \leq V_{RT};$ $V_{RO} \leq 0.4 \vee$	P_5.7.6
Reset Delay Timing	-			i			-
Power On Reset Delay Time	t _{rd}	17	25	37	ms	$C_{\rm D}$ = 100 nF Calculated value	P_5.7.8
Upper Delay Switching Threshold	V_{DU}	_	0.9	-	V	-	P_5.7.9
Lower Delay Switching Threshold	V_{DL}	_	0.6	-	V	-	P_5.7.10
Delay Capacitor Charge Current	$I_{D,ch}$	_	3.6	-	μA	<i>V</i> _D = 1 V	P_5.7.11
Delay Capacitor Discharge Current	$I_{D,dch}$	-	250	-	mA	<i>V</i> _D = 1 V	P_5.7.12
Delay Capacitor Discharge Time	t _{rr,d}	-	2	4	μs	$C_{\rm D}$ = 100 nF Calculated value	P_5.7.13
Internal Reset Reaction Time ¹⁾	t _{rr,int}	_	8	14	μs	C _D = 0 nF	P_5.7.14
Reset Reaction Time	t _{rr,total}	-	10	18	μs	$C_{\rm D}$ = 100 nF Calculated value	P_5.7.15

1) Parameter not subject to production test; specified by design.



5.8 Typical Performance Characteristics Reset

Typical Performance Characteristics

Undervoltage Reset Threshold $V_{\rm RT}$ versus Junction Temperature $T_{\rm j}$



Internal Reset Reaction Time $t_{\rm rr,int}$ versus Junction Temperature $T_{\rm j}$



Power On Reset Delay Time $t_{\rm rd}$ versus Junction Temperature $T_{\rm j}$





Application Information

6 Application Information

Note: The following information is given as a hint for the implementation of the device only and shall not be regarded as a description or warranty of a certain functionality, condition or quality of the device.

6.1 Application Diagram



Figure 6 Application Diagram TLS810D1

6.2 Selection of External Components

6.2.1 Input Pin

The typical input circuitry for a linear voltage regulator is shown in the application diagram above.

A ceramic capacitor at the input, in the range of 100 nF to 470 nF, is recommended to filter out the high frequency disturbances imposed by the line e.g. ISO pulses 3a/b. This capacitor must be placed very close to the input pin of the linear voltage regulator on the PCB.

An aluminum electrolytic capacitor in the range of 10 μ F to 470 μ F is recommended as an input buffer to smooth out high energy pulses, such as ISO pulse 2a. This capacitor should be placed close to the input pin of the linear voltage regulator on the PCB.

An overvoltage suppressor diode can be used to further suppress any high voltage beyond the maximum rating of the linear voltage regulator and protect the device against any damage due to over-voltage.

The external components at the input are not mandatory for the operation of the voltage regulator, but they are recommended in case of possible external disturbances.

6.2.2 Output Pin

An output capacitor is mandatory for the stability of linear voltage regulators.

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Application Information

The requirement to the output capacitor is given in "Functional Range" on Page 8. The graph "Output Capacitor Series Resistor ESR(C_q) versus Output Current I_q" on Page 13 shows the stable operation range of the device.

TLS810D1 is designed to be stable with extremely low ESR capacitors. According to the automotive environment, ceramic capacitors with X5R or X7R dielectrics are recommended.

The output capacitor should be placed as close as possible to the regulator's output and GND pins and on the same side of the PCB as the regulator itself.

In case of rapid transients of input voltage or load current, the capacitance should be dimensioned in accordance and verified in the real application that the output stability requirements are fulfilled.

6.3 Thermal Considerations

Knowing the input voltage, the output voltage and the load profile of the application, the total power dissipation can be calculated:

$$P_{\rm D} = (V_{\rm I} - V_{\rm O}) \times I_{\rm O} + V_{\rm I} \times I_{\rm q}$$

with

- $P_{\rm D}$: continuous power dissipation •
- $V_{\rm I}$: input voltage
- $V_{\rm Q}$: output voltage
- $I_{\rm O}$: output current
- I_a: quiescent current

The maximum acceptable thermal resistance R_{thJA} can then be calculated:

$$R_{thJA, max} = \frac{T_{j, max} - T_a}{P_D}$$
(6.2)

with

- $T_{j,max}$: maximum allowed junction temperature
- T_a : ambient temperature

Based on the above calculation the proper PCB type and the necessary heat sink area can be determined with reference to the specification in "Thermal Resistance" on Page 8.

Example

Application conditions:

 $V_1 = 13.5 \text{ V}$ $V_{\rm Q} = 5 \, {\rm V}$ $I_{0} = 80 \text{ mA}$ T_a = 105 °C Calculation of $R_{\text{thJA,max}}$: $P_{\rm D} = (V_{\rm I} - V_{\rm Q}) \times I_{\rm Q} + V_{\rm I} \times I_{\rm q}$ = (13.5V - 5V) x 80 mA + 13.5 V x 0.016 mA = 0.68 W

(6.1)



Application Information

 $R_{\text{thJA,max}} = (T_{\text{j,max}} - T_{\text{a}}) / P_{\text{D}}$

```
= 66.2 K/W
```

As a result, the PCB design must ensure a thermal resistance R_{thJA} lower than 66.2 K/W. According to "Thermal Resistance" on Page 8, at least 600 mm² heatsink area is needed on the FR4 1s0p PCB, or the FR4 2s2p board can be used.

6.4 Reverse Polarity Protection

TLS810D1 is not self protected against reverse polarity faults. To protect the device against negative supply voltage, an external reverse polarity diode is needed, as shown in **Figure 6**. The absolute maximum ratings of the device as specified in "Absolute Maximum Ratings" on Page 7 must be kept.

6.5 Further Application Information

• For further information you may contact http://www.infineon.com/



Package Outlines

7 Package Outlines



Figure 7 PG-DSO-8 EP

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

For further information on alternative packages, please visit our website: http://www.infineon.com/packages.



Revision History

8 Revision History

Revision	Date	Changes
1.0	2015-01-27	Data Sheet - Initial Version

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